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**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: MARTIN C. BLECK *ET AL.*

FILED: CONCURRENTLY HEREWITH  
FOR: **SEMICONDUCTOR PLATING SYSTEM  
WORKPIECE SUPPORT HAVING  
WORKPIECE-ENGAGING ELECTRODES  
WITH DISTAL CONTACT PART AND  
DIELECTRIC COVER**

**Preliminary Amendment**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Commissioner:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2.